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TITLE: NI-400	DOCUMENT NO: 98ARH98301A	REV: G
	STANDARD: NON-JEDEC	
	SOT1812-1	05 FEB 2016



NOTES:

1. CONTROLLING DIMENSION: INCH
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
3. DIMENSION H IS MEASURED .030 (0.762) AWAY FROM PACKAGE BODY.
4. INFORMATION ONLY:
CORNER BREAK (4X) TO BE .060±.005 (1.52±0.13) RADIUS OR
.06±.005 (1.52±0.13) x 45° CHAMFER.

STYLE 1
 PIN 1: DRAIN
 PIN 2: GATE
 PIN 3: SOURCE

DIM	INCH		MILLIMETER		DIM	INCH		MILLIMETER	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
A	.795	.805	20.19	20.44	R	.395	.405	10	10.3
B	.380	.390	9.65	9.9	S	.395	.405	10	10.3
C	.125	.163	3.17	4.14					
D	.275	.285	6.98	7.24	aaa	.005		0.127	
E	.035	.045	0.89	1.14	bbb	.010		0.254	
F	.004	.006	0.10	0.15	ccc	.015		0.381	
G	.600 BSC		15.24 BSC		-	-	-	-	-
H	.057	.067	1.45	1.7	-	-	-	-	-
K	.092	.122	2.33	3.1	-	-	-	-	-
M	.395	.405	10	10.3	-	-	-	-	-
N	.395	.405	10	10.3	-	-	-	-	-
Q	∅.120	∅.130	∅3.05	∅3.3	-	-	-	-	-

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